SKKT 162 H4, SKKH 162 H4

SEMIPACK® 2

Thyristor / Diode Modules

SKKH 162 H4

SKKT 162 H4

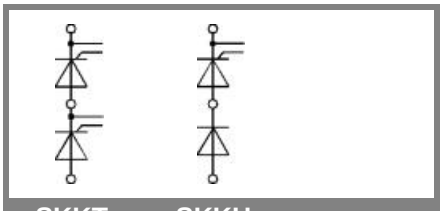
Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

Typical Applications*

- DC motor control (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

1) See the assembly instructions



SKKT SKKH

V_{RSM} V	V_{RRM}, V_{DRM} V	I_{TRMS} = 250 A (maximum value for continuous operation) I_{TAV} = 162 A (sin.180; T_c = 77 °C)		
2100	2000	SKKT 162/20E H4	SKKH 162/20E H4	
2300	2200	SKKT 162/22E H4	SKKH 162/22E H4	

Symbol	Conditions	Values	Units
I_{TAV}	sin. 180; T_c = 85 (100) °C;	143 (101)	A
I_{TSM}	T_{vj} = 25 °C; 10 ms	5200	A
	T_{vj} = 125 °C; 10 ms	4800	A
i²t	T_{vj} = 25 °C; 8,3 ... 10 ms	135000	A²s
	T_{vj} = 125 °C; 8,3 ... 10 ms	115000	A²s
V_T	T_{vj} = 25 °C; I_T = 500 A	max. 1,65	V
$V_{T(TO)}$	T_{vj} = 125 °C	max. 0,95	V
r_T	T_{vj} = 125 °C	max. 2	mΩ
I_{DD}; I_{RD}	T_{vj} = 125 °C; V_{RD} = V_{RRM}; V_{DD} = V_{DRM}	max. 60	mA
t_{gd}	T_{vj} = 25 °C; I_G = 1 A; di_G/dt = 1 A/µs	1	µs
t_{gr}	V_D = 0,67 * V_{DRM}	2	µs
$(di/dt)_{cr}$	T_{vj} = 125 °C	max. 200	A/µs
$(dv/dt)_{cr}$	T_{vj} = 125 °C	max. 1000	V/µs
t_q	T_{vj} = 125 °C ,	50 ... 150	µs
I_H	T_{vj} = 25 °C; typ. / max.	150 / 400	mA
I_L	T_{vj} = 25 °C; R_G = 33 Ω; typ. / max.	300 / 1000	mA
V_{GT}	T_{vj} = 25 °C; d.c.	min. 2	V
I_{GT}	T_{vj} = 25 °C; d.c.	min. 150	mA
V_{GD}	T_{vj} = 125 °C; d.c.	max. 0,25	V
I_{GD}	T_{vj} = 125 °C; d.c.	max. 10	mA
$R_{th(j-c)}$	cont.; per thyristor / per module	0,16 / 0,08	K/W
$R_{th(j-c)}$	sin. 180; per thyristor / per module	0,17 / 0,085	K/W
$R_{th(j-c)}$	rec. 120; per thyristor / per module	0,19 / 0,095	K/W
$R_{th(c-s)}$	per thyristor / per module	0,1 / 0,05	K/W
T_{vj}		- 40 ... + 125	°C
T_{stg}		- 40 ... + 125	°C
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	4800 / 4000	V~
M_s	to heatsink	5 ± 15 %[1)]	Nm
M_t	to terminal	5 ± 15 %	Nm
a		5 * 9,81	m/s²
m	approx.	175	g
Case	SKKT	A 21	
	SKKH	A 22	

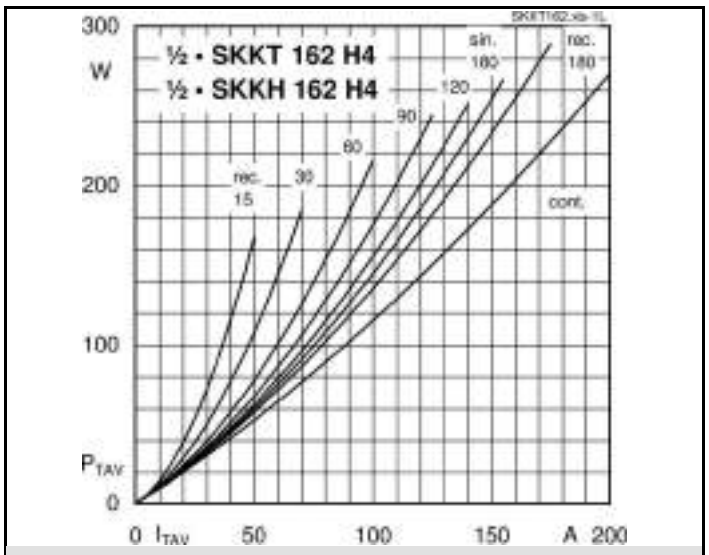


Fig. 1L Power dissipation per thyristor vs. on-state current

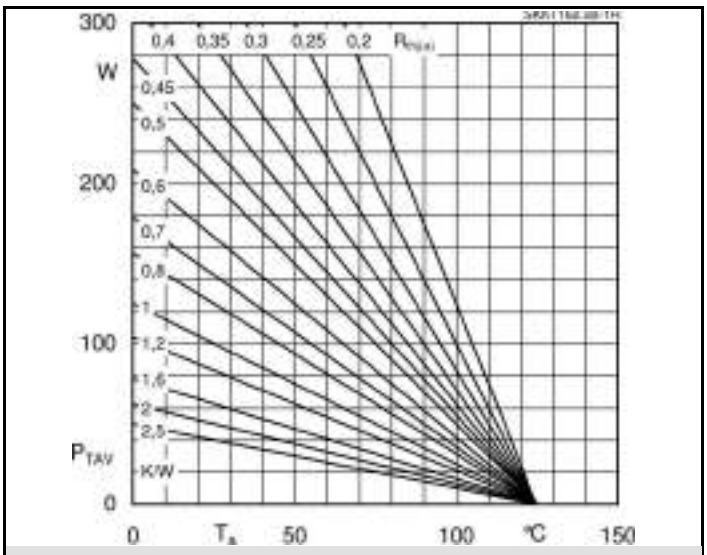


Fig. 1R Power dissipation per thyristor vs. ambient temp.

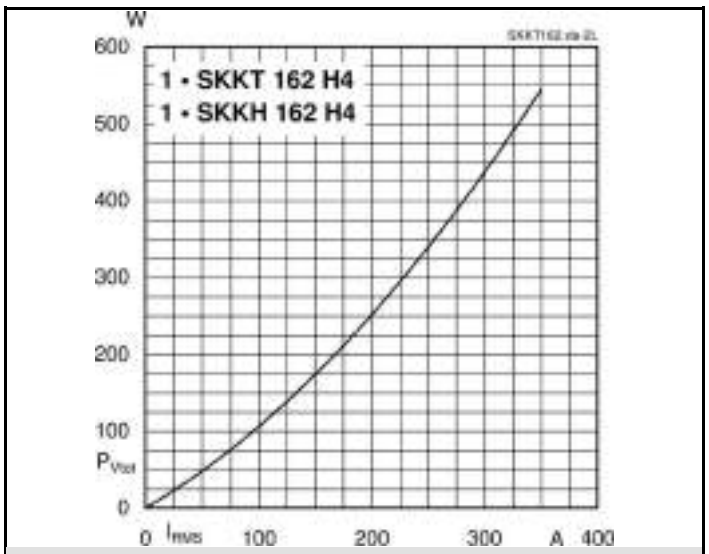


Fig. 2L Power dissipation per module vs. rms current

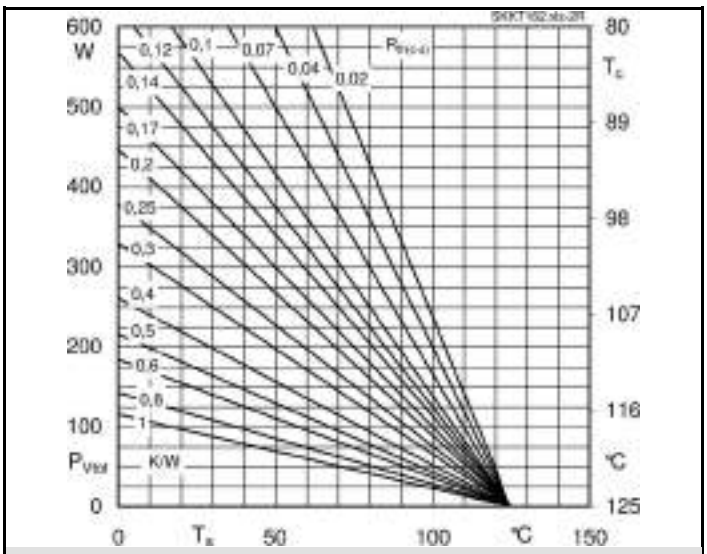


Fig. 2R Power dissipation per module vs. case temp.

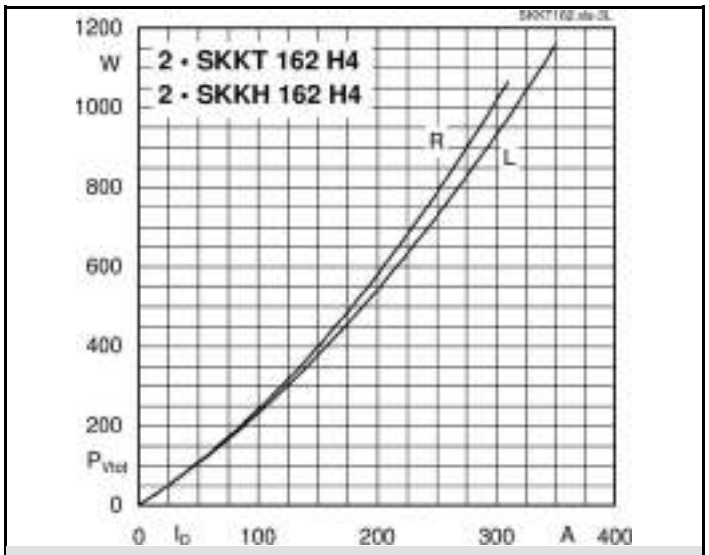


Fig. 3L Power dissipation of two modules vs. direct current

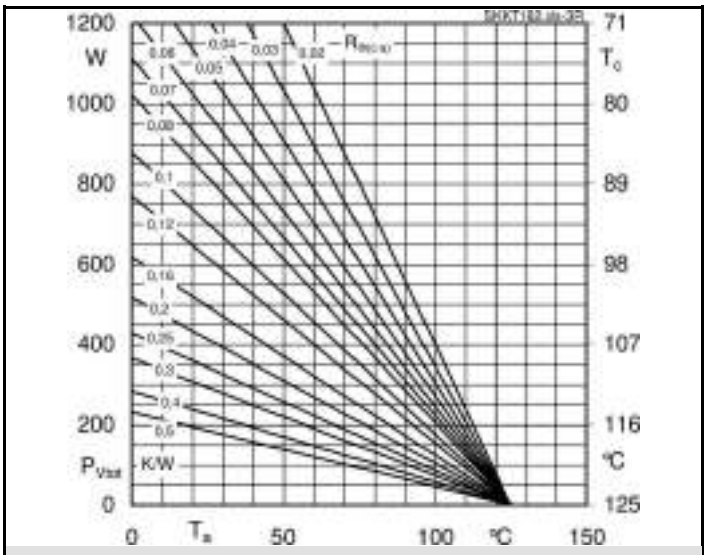


Fig. 3R Power dissipation of two modules vs. case temp.

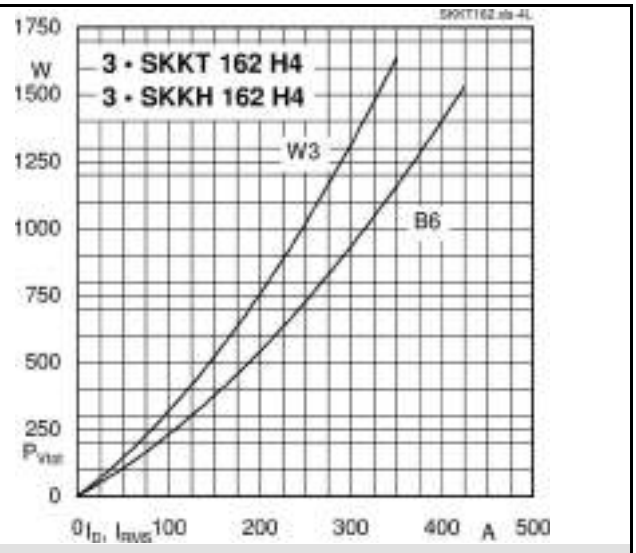


Fig. 4L Power dissipation of three modules vs. direct and rms current

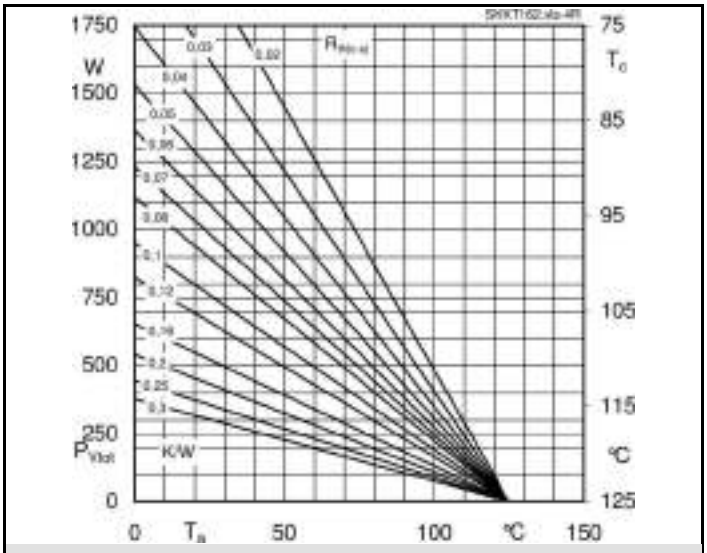


Fig. 4R Power dissipation of three modules vs. case temp.

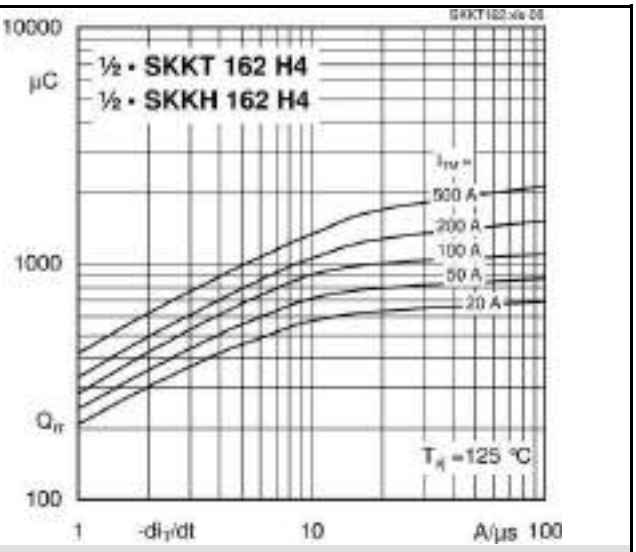


Fig. 5 Recovered charge vs. current decrease

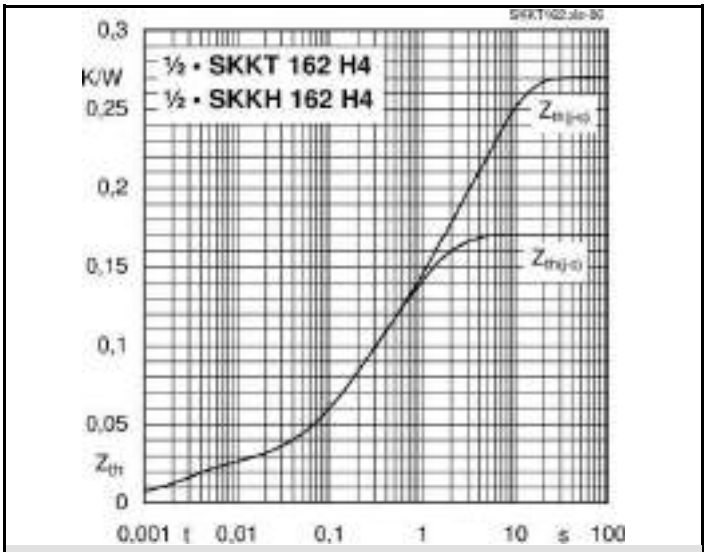


Fig. 6 Transient thermal impedance vs. time

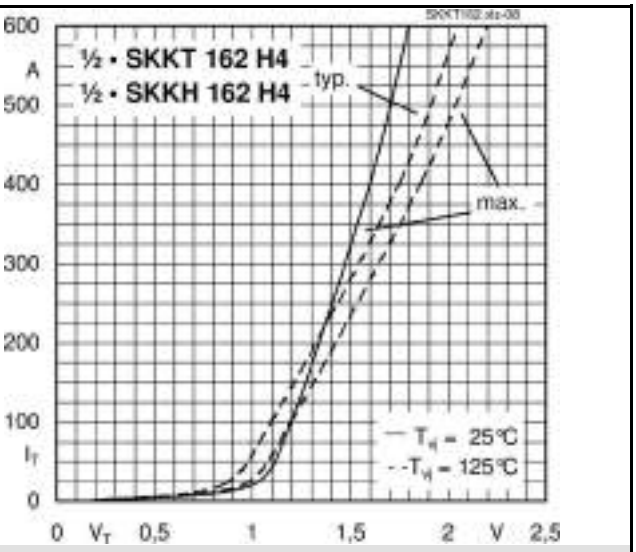


Fig. 7 On-state characteristics

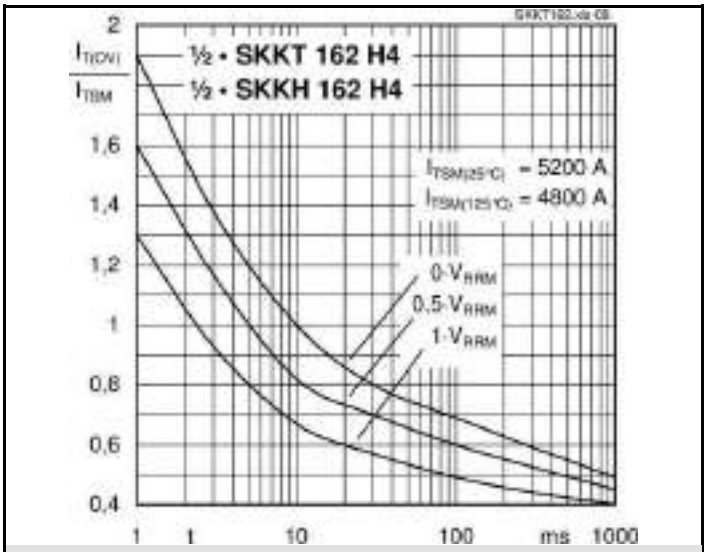


Fig. 8 Surge overload current vs. time

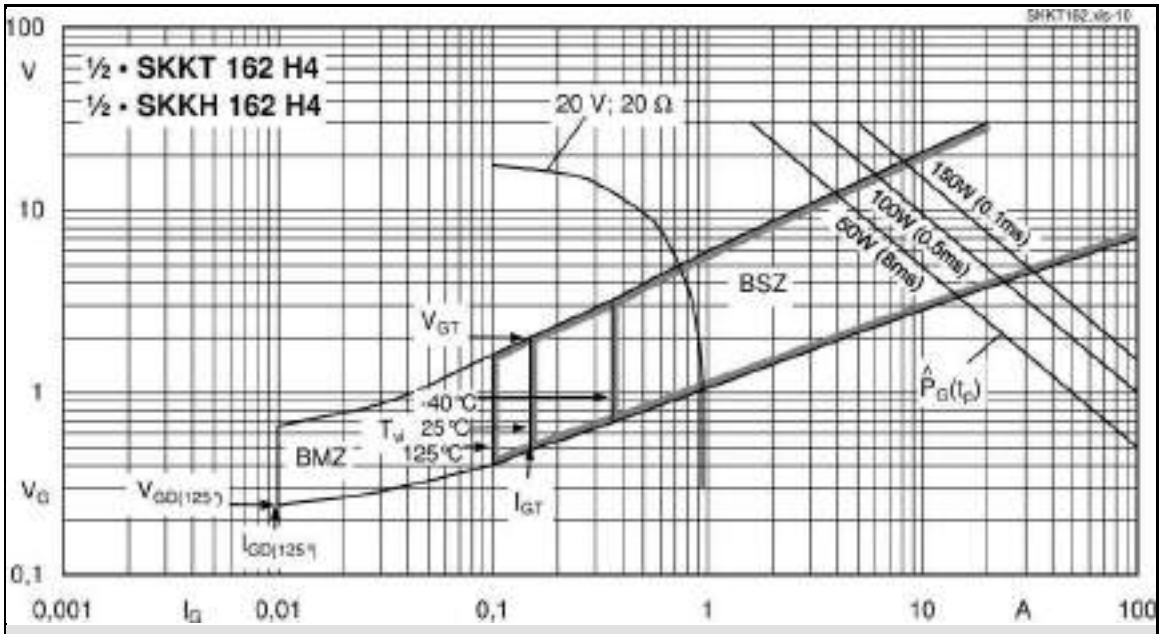
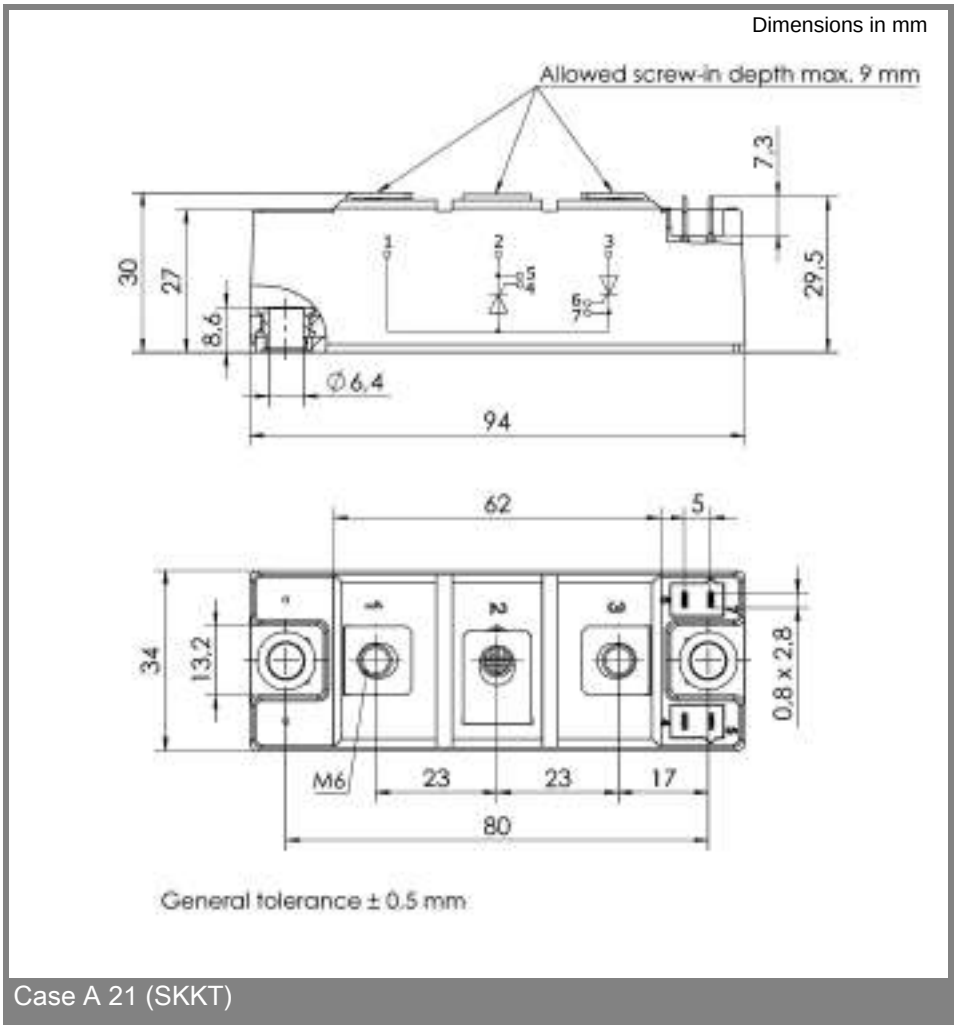
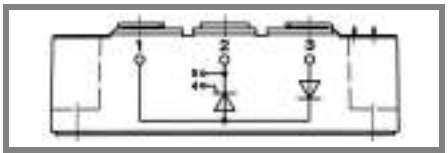


Fig. 9 Gate trigger characteristics



Case A 21 (SKKT)


Case A 22 SKKH

This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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